

### AMP | AMPSEAL

TE Internal #: 776163-4

PCB Mount Header, Horizontal, Wire-to-Device / Wire-to-Board, 35

Position, .157 in [4 mm] Centerline, Fully Shrouded, Tin (Sn),

**AMPSEAL** 

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Connectors > PCB Connectors > PCB Headers & Receptacles > AMPSEAL PCB Horizontal Headers



Connector System: Wire-to-Board, Wire-to-Device

Number of Positions: 35

Centerline (Pitch): 4 mm [.157 in]

Sealable: Yes

PCB Mount Orientation: Horizontal

All AMPSEAL PCB Horizontal Headers (37)

### **Features**

### **Product Type Features**

Hybrid Header	No
Connector & Housing Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board, Wire-to-Device
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board

### **Configuration Features**

Number of Sections	1
Number of Signal Positions	35
Number of Positions	35
PCB Mount Orientation	Horizontal
Number of Rows	3

### **Electrical Characteristics**

Voltage Rating (Max)	250 VAC
Nominal Voltage Architecture	12 V, 24 V, 42 V, 48 V, 240 V



Coperating Voltage     250 VAC       Body Features     Gray       Connector Code     21, 9       Contact Features     1.3mm       Contact Size     1.3mm       Contact Type     Pin       Mating Pin Diameter     1.3 mm[.051 in]       Contact Mating Area Plating Material     Tin (Sn)       Termination Features     Through Hole - Solder       Mechanical Attachment     With       Mating Alignment Type     Keyed       Mating Retention     With       Mating Alignment     With       PCB Mount Alignment     With       Panel Mount Feature     Without       PCB Mount Retention     With       PCB Mount Retention Type     Boardlock       Mating Retention Type     Board Mount       Mating Retention Type     Board Mount       Connector Mounting Type     Board Mount
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Mating Retention Type  Connector Mounting Type  Board Mount
Connector Mounting Type  Board Mount
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Housing Features
Centerline (Pitch) 4 mm[.157 in]
Dimensions
Connector Length 76.9 mm[3.03 in]
Connector Width 37.9 mm[1.498 in]
PCB Thickness (Recommended)  1.57 mm[.062 in]
Profile Height from PCB 23.6 mm[.929 in]
Usage Conditions
Operating Temperature (Max)  65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100 °C, 105 °C[149 °F][158 °F][167 °F][176 °F]  [185 °F][194 °F][212 °F][221 °F]



Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]
Operation/Application	
Shielded	No
Circuit Application	Power & Signal
Industry Standards	
Degree of Protection	IP6K9K
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

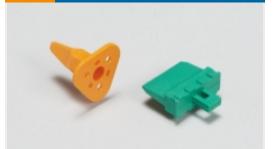




# Also in the Series | AMPSEAL



Automotive Connector Caps & Covers
(7)



Automotive Connector Locks & Position Assurance(1)



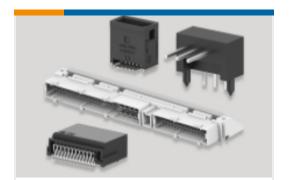
Automotive Housings(31)



Automotive Seals & Cavity Plugs(1)



Automotive Terminals(8)



PCB Headers & Receptacles(72)

# Customers Also Bought

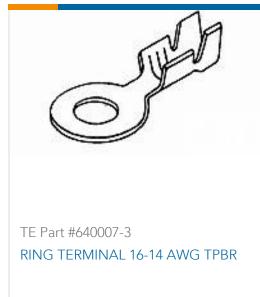




















TE Part #M513X-10191X-500PS PRESS XDCR M513X-10191X-500PS

### **Documents**

### **Product Drawings**

35P AMPSEAL HDR ASSY W/GASKET

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_776163-4\_S.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_776163-4\_S.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_776163-4\_S.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## Datasheets & Catalog Pages

**AMPSEAL Connector Catalog** 

English

ICT Terminals and Connectors Catalogue

English

## **Product Specifications**

**Application Specification** 

English

### **Agency Approvals**

**UL Report** 

English